SWITCHMODE **Power Rectifier**

DPAK Surface Mount Package

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

Features

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage
- ESD Rating:
 - ♦ Human Body Model = 3B (> 8 kV)
 - Machine Model = C (> 400 V)
- NRVUD Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant*

Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



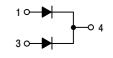
ON Semiconductor®

http://onsemi.com

ULTRAFAST RECTIFIER 6.0 AMPERES **200 VOLTS**



CASE 369C



MARKING DIAGRAM



= Assembly Location A v = Year ww = Work Week

- U620T = Device Code G
 - = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
MURD620CTG	DPAK (Pb-Free)	75 Units / Rail
NRVUD620CTG	DPAK (Pb-Free)	75 Units / Rail
MURD620CTT4G	DPAK (Pb-Free)	2,500 / Tape & Reel
NRVUD620CTT4G	DPAK (Pb-Free)	2,500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Forward Current (Rated V _R , T _C = 140°C) Per Diode Per Device	I _{F(AV)}	3.0 6.0	A
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz, T _C = 145°C) Per Diode	I _F	6.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, 60 Hz)	I _{FSM}	50	А
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +175	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS (Per Diode)

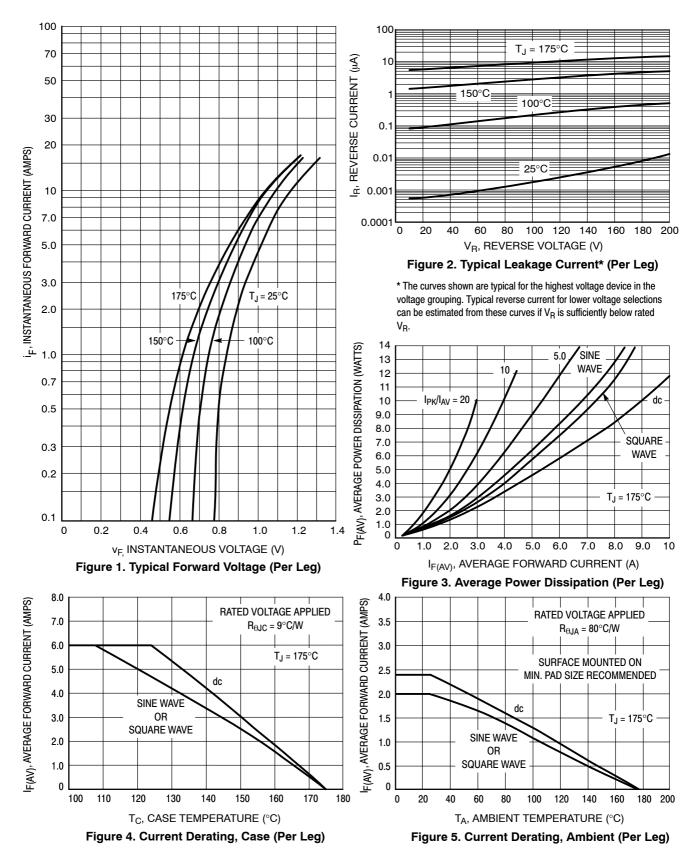
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{ hetaJC}$	9	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{ hetaJA}$	80	°C/W

1. Rating applies when surface mounted on the minimum pad sizes recommended.

ELECTRICAL CHARACTERISTICS (Per Diode)

Characteristic	Symbol	Value	Unit
	VF	1 0.96 1.2 1.13	V
Maximum Instantaneous Reverse Current (Note 2) $(T_J = 25^{\circ}C, Rated dc Voltage)$ $(T_J = 125^{\circ}C, Rated dc Voltage)$	i _R	5 250	μΑ
$ \begin{array}{l} \mbox{Maximum Reverse Recovery Time} \\ (I_F = 1 \mbox{ Amp, di/dt} = 50 \mbox{ Amps/} \mu s, \mbox{ V}_R = 30 \mbox{ V, } T_J = 25^{\circ} C) \\ (I_F = 0.5 \mbox{ Amp, i}_R = 1 \mbox{ Amp, I}_{REC} = 0.25 \mbox{ A, } V_R = 30 \mbox{ V, } T_J = 25^{\circ} C) \end{array} $	t _{rr}	35 25	ns

2. Pulse Test: Pulse Width = 300 $\mu s,$ Duty Cycle \leq 2.0%.



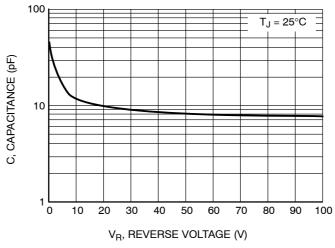
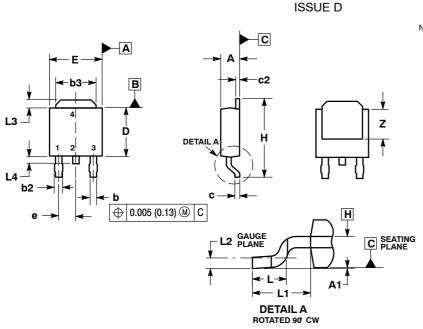


Figure 6. Typical Capacitance (Per Leg)

PACKAGE DIMENSIONS

DPAK (SINGLE GAUGE) CASE 369C

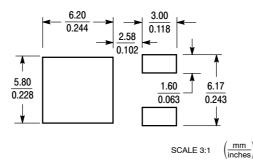


NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: INCHES. 3. THERMAL PAD CONTOUR OPTIONAL WITHIN DI-
- THERMAL PAD CONTOUR OPTIONAL WITHIN DI-MENSIONS b3, L3 and Z.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.006 INCHES PER SIDE
- NOT EXCEED 0.006 INCHES PER SIDE. 5. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 6. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.086	0.094	2.18	2.38
A1	0.000	0.005	0.00	0.13
b	0.025	0.035	0.63	0.89
b2	0.030	0.045	0.76	1.14
b3	0.180	0.215	4.57	5.46
С	0.018	0.024	0.46	0.61
c2	0.018	0.024	0.46	0.61
D	0.235	0.245	5.97	6.22
E	0.250	0.265	6.35	6.73
е	0.090 BSC		2.29 BSC	
Н	0.370	0.410	9.40	10.41
L	0.055	0.070	1.40	1.78
L1	0.108 REF		2.74 REF	
L2	0.020 BSC		0.51 BSC	
L3	0.035	0.050	0.89	1.27
L4		0.040		1.01
Z	0.155		3.93	

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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